

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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RoHS2(10 substances conformity)

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cases where the application will demand a high level of reliability, such as automotive, please contact a company representative for further information. ፓ ТО SHOCK CODE NO. (OLD) REMARKS SOLDERABILITY RESISTANCE DRY HEAT RAPID CHANGE DAMP HEAT VIBRATION GENERAL CORROSION SALT MIST TEMPERATURE ENVIRONMENTAL MECHAN I CAL AND WITHDRAWAL FORCES CONNECTOR INSERTION CONTACT INSERTION (STEADY STATE) MECHANICAL VOLTAGE PROOF CONTACT RESISTANCE ELECTRIC CHARACTERISTICS CONSTRUCTION APPL I CABLE HEAT (FLOW NSULATION RATING COUNT :Qualification Test **EXAMINATION** VOL TAGE OPERATING TEMPERATURE SOLDER ING) RESISTANCE I TEM OPERATION TO SOLDERING 유 STANDARD DESCRIPTION OF specified, HIROSE ELECTRIC CO., AND CHARACTERISTICS TIME 30 $\phi 1.47_0^{+0.003}$ $\phi 1.53^{\circ}_{-0.003}$ SOLDER TEMPERATURE, +350± IMMERSION, DURATION, SOLDER TEMPERATURE, +350 ± 10°C, FOR EXPOSED AT + EXPOSED IN 5 % SALT WATER SPRAY FOR 48 h. UNDER 5 CYCLES. TEMPERATURE EXPOSED AT 40 °C, MEASURED BY APPLICABLE CONNECTOR CONTACT SHALL BE MEASURED AT DC IMMERSION, DURATION, EXPOSED AT -CONFIRMED VISUALLY VISUALLY AND BY MEASURING INSTRUMENT AT:Assurance Test FREQUENCY 10 TO 55 Hz, 500 CHARACTERISTICS 490 M/s2 DIRECTIONS OF REVISIONS 500 8 RANGE TIMES DRAWING NO đ $-- m/s^2 AT 2 h$ JIS C V AC FOR 1 min. 10 TO 15 INSERTIONS AND EXTRACTIONS -55→ 55 °C ස ර <u>[</u>] (R/T:ROOM TEMPERATURE) 5042 В 10 SPEC 90 10 95 %, ₹ | TEST METHOD ð 0 96 h. 96 h. 150 욹 w O:Applicable Test 0 30 → 10 TO 15 min °C T0 SINGLE AMPLITUDE 0, 75 SPECIFICATION ş ٧, 10°C **PULSE** BY STEEL GAUGE BY STEEL GAUGE တ +65 → ယ V 8 _ T] DATE FOR 11 ms 96 +70 00 DIRECTIONS 200 R/T °C O _ ე < റ്റ 0 4 : M. St. Wall V > ⋗ DRAWN _ COUNT SHEET STORAGE TEMPERATURE RANGE APPLICABLE CABLE CODE **⊚** ⊖ NO SOLDER CLUSTER NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 중 중 Θ Θ WETTING ON SOLDER SURFACE LOOSENESS OF THE TERMINALS NO DEFORMATION OF CASE OF EXCESSIVE (3)NO DAMAGE CRACK AND LOOSENESS ②INSULATION RESISTANCE: 100 MΩ MIN (ATDRY) @NO DAMAGE, CRACK AND LOOSENESS, OF PARTS ©NO DAMAGE, CRACK AND LOOSENESS, OF PARTS

O NO ELECTRICAL DISCONTINUITY OF 10 µs. Θ INSERTION AND WITHDRAWAL FORCES INSERTION AND WITHDRAWAL FORCES INSERTION AND WITHDRAWAL FORCES NO FLASHOVER OR BREAKDOWN LOCKING DEVICE WITH LOCK LOCKING DEVICE WITH UNLOCK: - N MAX **ACCORDING** SNO C HEAVY CORROSIN DAMAGE, CRACK INSULATION RESISTANCE: CONTACT RESISTANCE: 8 DESCRIPTION OF REVISIONS NO ELECTRICAL DISCONTINUITY OF 10 μs. NO DAMAGE CRACK AND LOOSENESS OF PARTS. INSULATION RESISTANCE: 100 M Q MAX. (AT HIGH HUMIDITY) 1000 DESIGNED Ċ (1) May (1) PART NO. TO DRAWING Z ms Max mΩ NAX __ J MIN CM ω AND O H, Zemba REQUIREMENTS 0 CHECKED N L00SENESS ্ৰ _ 5 _0 N Ø Š 10 M. Sa 유 T 10 ~40 N mΩ MAX. APPROVED OF PARTS. ΒY PARTS. 7 င် 10 μs. $\phi 4 \pm 0.2$ 왕 0.2 10 4 N MAX رد Z +60 7 Ξ DATE QΤ X х X × Х × Х х ငိ х X X х х X ΤA x x × × X

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RoHS2(10 substances conformity) 2018/08/22 02:01:47(JST) Rachelle Sheffer DRAWING FOR REFERENCE: This is subject to change without notice In cases where the application will demand a high level of reliability, such as automotive, please contact a company representative for further information. \mathcal{D} ϖ \circ O ш 2 0 20 ₩ PHOSPHOR PHOSPHOR POLYAMIDE DESCRIPTION MATERIA BRONZE DRAWING 9 \Box REVISIONS SILVER (BLUE) \bigcirc <u>г</u> ILVER 4 FINISH, \circ ELECTRIC PLA PLATING 0 œ 15.0 \$\psi \psi 0.5 \odot CHKD REMARKS Ħ W ∞ CO.,LTD. 6-7 E. Yumino 05,09.26 (12.0) 合当 N O α U O E Yumino Hizemb 05,09.26 BRASS BRAS POLYVINYLCHLORIDE POLYVINYLCHLORIDE DESCRIPTION \Box $\hat{\sigma}$ N) \bigcirc 2 9 0 13-13 REVISIONS NICKEL NICKEL TRANSPARENCY TRANSPARENCY 8 0 2 FINISH, 65.09.28 U Ω PLATING PLATING 2 S REMARKS _

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